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[International Rectifier \(Infineon Technologies Americas Corp.\)
IRF5810TRPBF](#)

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sales@integrated-circuit.com

International IR Rectifier

PD - 95469B

IRF5810PbF

HEXFET® Power MOSFET

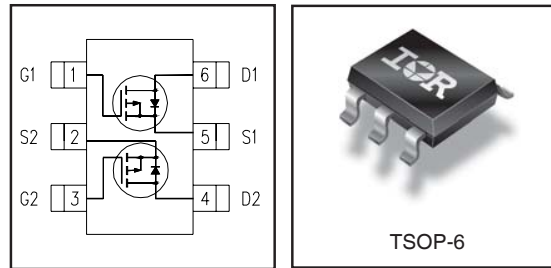
- Ultra Low On-Resistance
- Dual P-Channel MOSFET
- Surface Mount
- Available in Tape & Reel
- Low Gate Charge
- Lead-Free
- Halogen-Free

| V _{DSS} | R _{DS(on)} max (mΩ) | I _D |
|------------------|-------------------------------|----------------|
| -20V | 90 @ V _{GS} = -4.5V | -2.9A |
| | 135 @ V _{GS} = -2.5V | -2.3A |

Description

These P-channel HEXFET® Power MOSFETs from International Rectifier utilize advanced processing techniques to achieve the extremely low on-resistance per silicon area. This benefit provides the designer with an extremely efficient device for use in battery and load management applications.

This Dual TSOP-6 package is ideal for applications where printed circuit board space is at a premium and where maximum functionality is required. With two die per package, the IRF5810 can provide the functionality of two SOT-23 packages in a smaller footprint. Its unique thermal design and R_{DS(on)} reduction enables an increase in current-handling capability.



Absolute Maximum Ratings

| | Parameter | Max. | Units |
|--|---|--------------|-------|
| V _{DS} | Drain- Source Voltage | -20 | V |
| I _D @ T _A = 25°C | Continuous Drain Current, V _{GS} @ -4.5V | -2.9 | A |
| I _D @ T _A = 70°C | Continuous Drain Current, V _{GS} @ -4.5V | -2.3 | |
| I _{DM} | Pulsed Drain Current ① | -11 | |
| P _D @ T _A = 25°C | Power Dissipation ③ | 0.96 | W |
| P _D @ T _A = 70°C | Power Dissipation ③ | 0.62 | |
| | Linear Derating Factor | 0.008 | mW/°C |
| V _{GS} | Gate-to-Source Voltage | ± 12 | V |
| T _J , T _{STG} | Junction and Storage Temperature Range | -55 to + 150 | °C |

Thermal Resistance

| | Parameter | Max. | Units |
|------------------|------------------------------|------|-------|
| R _{θJA} | Maximum Junction-to-Ambient③ | 130 | °C/W |

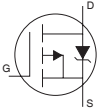
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Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|---------------------------------|--------------------------------------|-------|-------|------|---------------------|--|
| $V_{(BR)DSS}$ | Drain-to-Source Breakdown Voltage | -20 | — | — | V | $V_{GS} = 0V, I_D = -250\mu A$ |
| $\Delta V_{(BR)DSS}/\Delta T_J$ | Breakdown Voltage Temp. Coefficient | — | 0.011 | — | V/ $^\circ\text{C}$ | Reference to $25^\circ\text{C}, I_D = -1\text{mA}$ |
| $R_{DS(on)}$ | Static Drain-to-Source On-Resistance | — | 60 | 90 | m Ω | $V_{GS} = -4.5V, I_D = -2.9 \text{ ②}$ |
| | | — | 87 | 135 | | $V_{GS} = -2.5V, I_D = -2.3A \text{ ②}$ |
| $V_{GS(th)}$ | Gate Threshold Voltage | -0.45 | — | -1.2 | V | $V_{DS} = V_{GS}, I_D = -250\mu A$ |
| g_{fs} | Forward Transconductance | 5.4 | — | — | S | $V_{DS} = -10V, I_D = -2.9A$ |
| I_{DSS} | Drain-to-Source Leakage Current | — | — | -1.0 | μA | $V_{DS} = -16V, V_{GS} = 0V$ |
| | | — | — | -25 | | $V_{DS} = -16V, V_{GS} = 0V, T_J = 70^\circ\text{C}$ |
| I_{GSS} | Gate-to-Source Forward Leakage | — | — | -100 | nA | $V_{GS} = -12V$ |
| | Gate-to-Source Reverse Leakage | — | — | 100 | | $V_{GS} = 12V$ |
| Q_g | Total Gate Charge | — | 6.4 | 9.6 | nC | $I_D = -2.9A$ |
| Q_{gs} | Gate-to-Source Charge | — | 1.2 | 1.8 | | $V_{DS} = -10V$ |
| Q_{gd} | Gate-to-Drain ("Miller") Charge | — | 1.7 | 2.6 | | $V_{GS} = -4.5V$ |
| $t_{d(on)}$ | Turn-On Delay Time | — | 8.2 | — | ns | $V_{DD} = -10V \text{ ②}$ |
| t_r | Rise Time | — | 14 | — | | $I_D = -1.0A$ |
| $t_{d(off)}$ | Turn-Off Delay Time | — | 62 | — | | $R_G = 6.0\Omega$ |
| t_f | Fall Time | — | 53 | — | | $V_{GS} = -4.5V$ |
| C_{iss} | Input Capacitance | — | 650 | — | pF | $V_{GS} = 0V$ |
| C_{oss} | Output Capacitance | — | 110 | — | | $V_{DS} = -16V$ |
| C_{riss} | Reverse Transfer Capacitance | — | 86 | — | | $f = 1\text{kHz}$ |

Source-Drain Ratings and Characteristics

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|----------|--|------|------|------|-------|--|
| I_S | Continuous Source Current (Body Diode) | — | — | -1.0 | A | MOSFET symbol showing the integral reverse p-n junction diode.  |
| I_{SM} | Pulsed Source Current (Body Diode) ① | — | — | -11 | | |
| V_{SD} | Diode Forward Voltage | — | — | -1.2 | V | $T_J = 25^\circ\text{C}, I_S = -1.0A, V_{GS} = 0V \text{ ②}$ |
| t_{rr} | Reverse Recovery Time | — | 110 | 170 | ns | $T_J = 25^\circ\text{C}, I_F = -1.0A$ |
| Q_{rr} | Reverse Recovery Charge | — | 130 | 200 | nC | $di/dt = -100A/\mu s \text{ ②}$ |

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Pulse width $\leq 400\mu s$; duty cycle $\leq 2\%$.
- ③ Surface mounted on 1 in square Cu board

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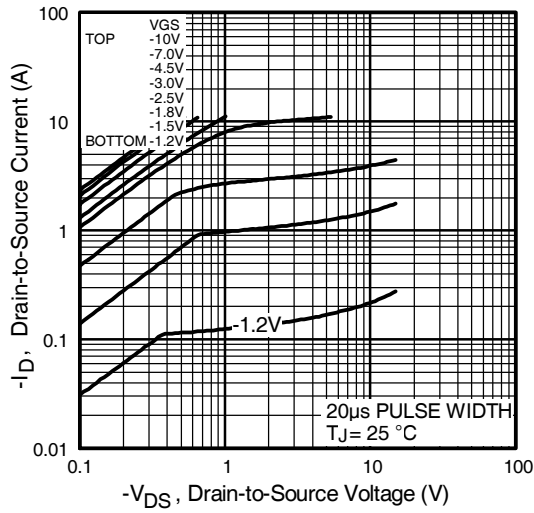


Fig 1. Typical Output Characteristics

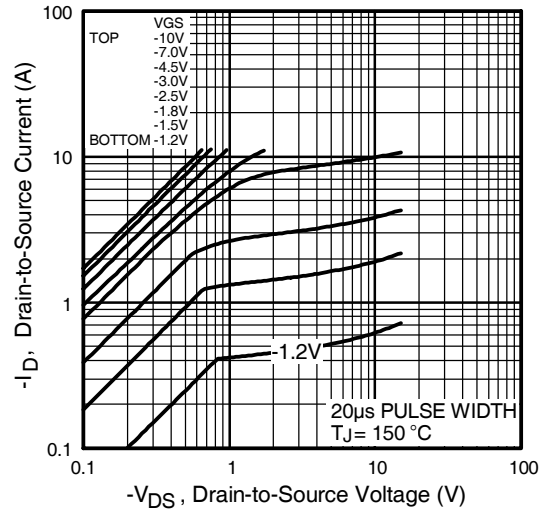


Fig 2. Typical Output Characteristics

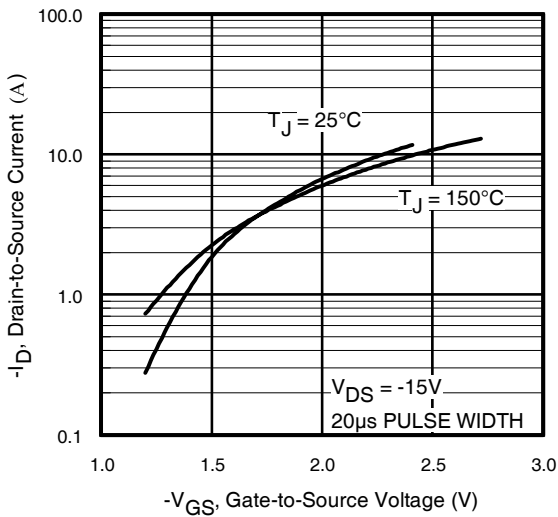


Fig 3. Typical Transfer Characteristics

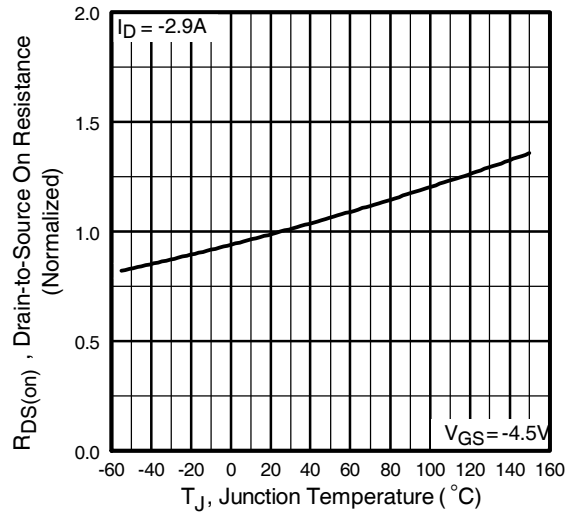


Fig 4. Normalized On-Resistance Vs. Temperature

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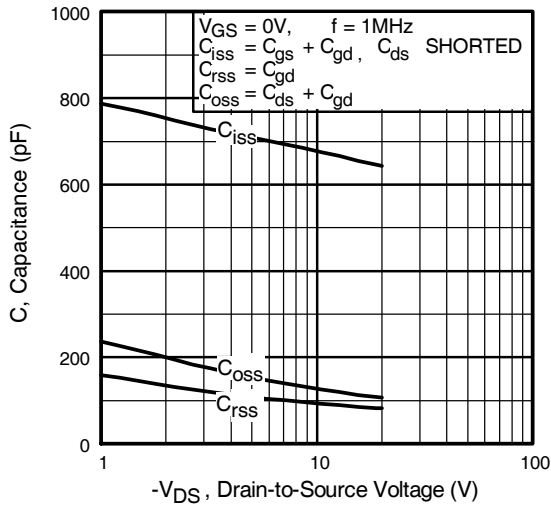


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

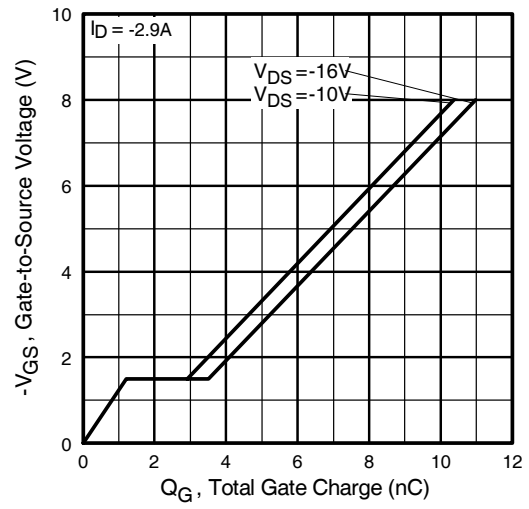


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

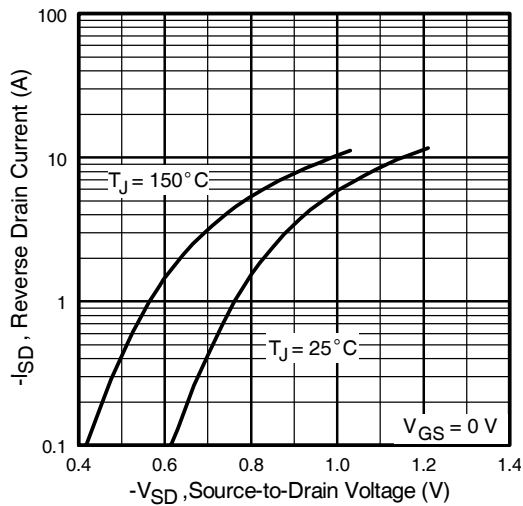


Fig 7. Typical Source-Drain Diode Forward Voltage

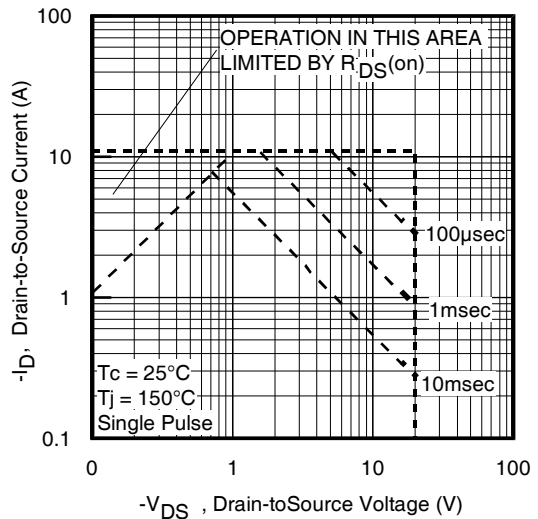


Fig 8. Maximum Safe Operating Area

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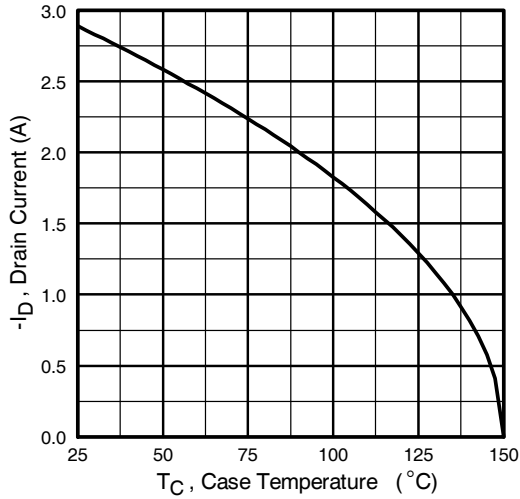


Fig 9. Maximum Drain Current Vs. Case Temperature

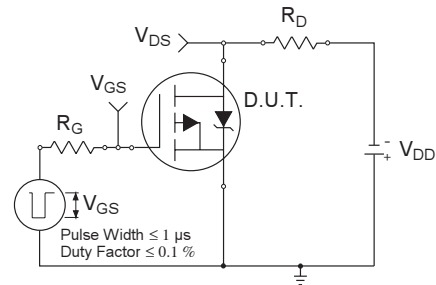


Fig 10a. Switching Time Test Circuit

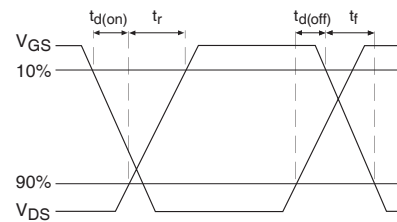


Fig 10b. Switching Time Waveforms

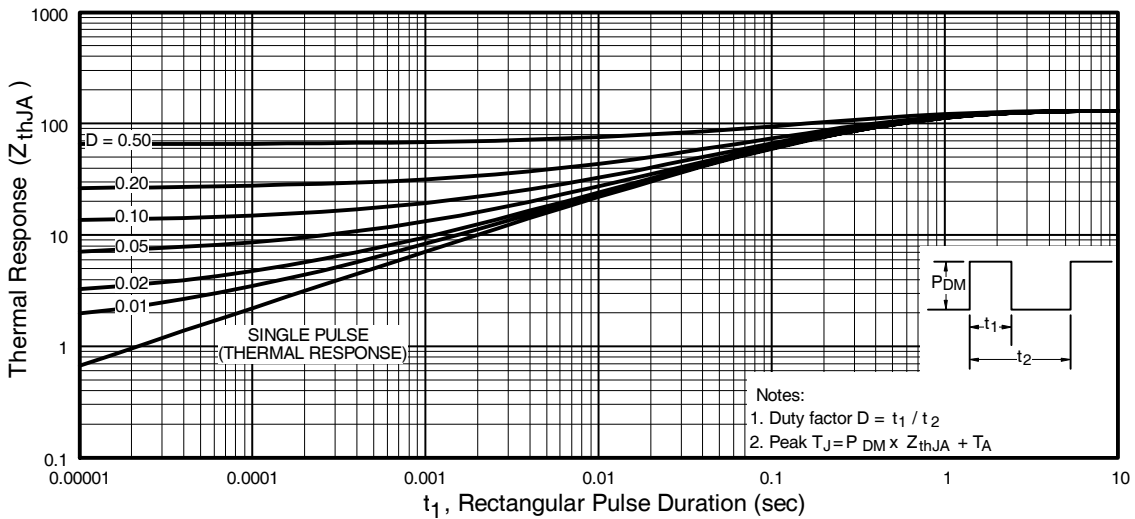


Fig 11. Typical Effective Transient Thermal Impedance, Junction-to-Ambient

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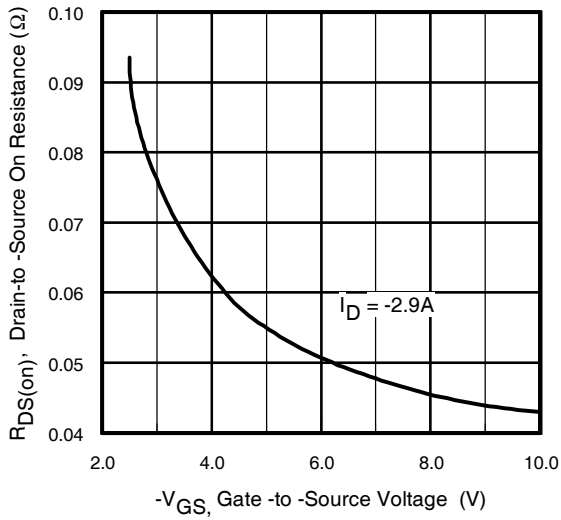


Fig 12. Typical On-Resistance Vs. Gate Voltage

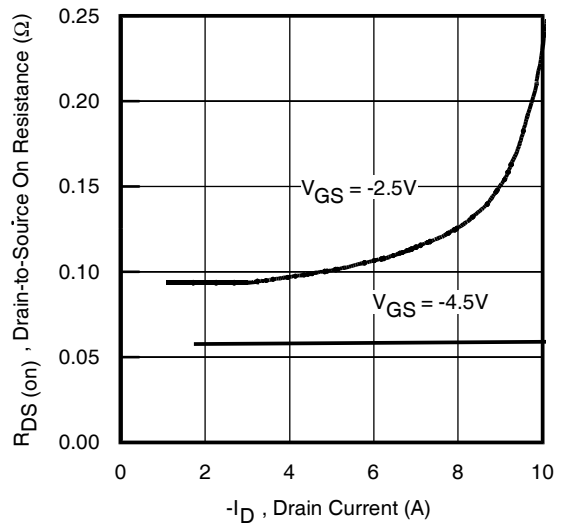


Fig 13. Typical On-Resistance Vs. Drain Current

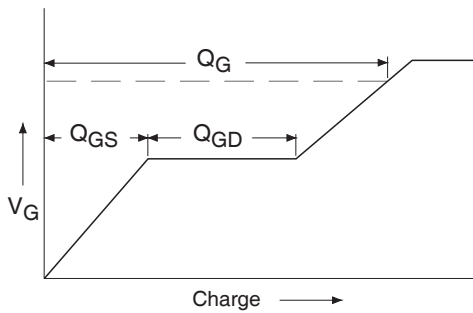


Fig 14a. Basic Gate Charge Waveform

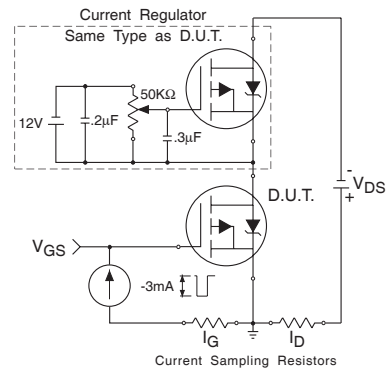


Fig 14b. Gate Charge Test Circuit

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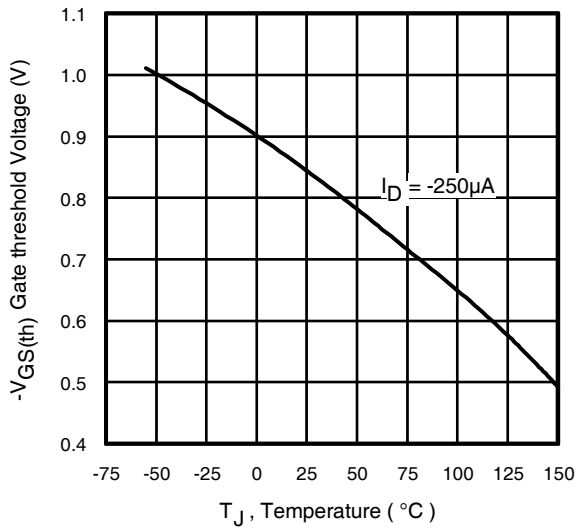


Fig 15. Threshold Voltage Vs. Temperature

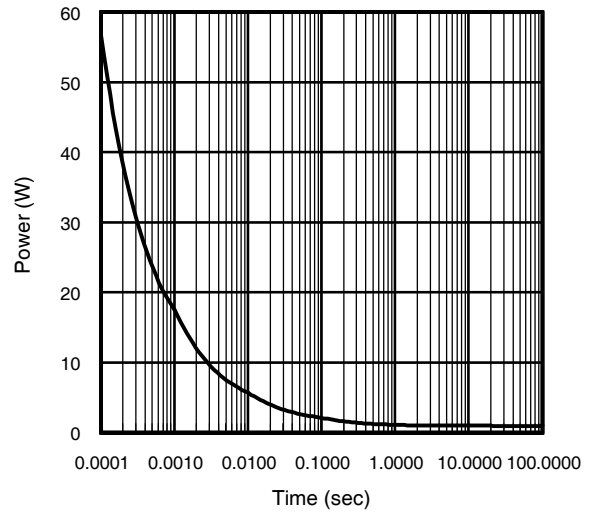
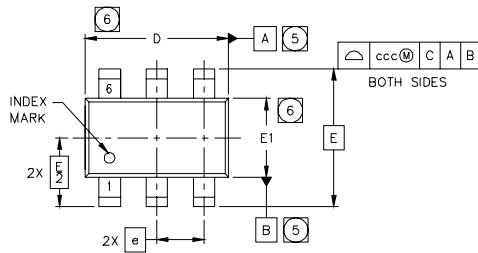


Fig 16. Typical Power Vs. Time

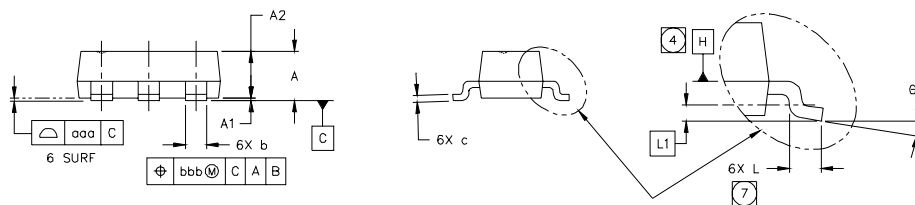
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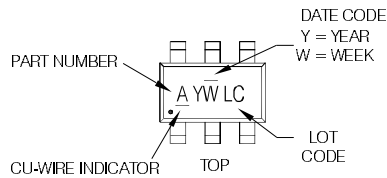
TSOP-6 Package Outline



| SYMBOL | MO-193AA DIMENSIONS | | | | | |
|--------|---------------------|------|------|-----------|-------|-------|
| | MILLIMETERS | | | INCHES | | |
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | --- | --- | 1.10 | --- | --- | .0433 |
| A1 | 0.01 | --- | 0.10 | .0004 | --- | .0039 |
| A2 | 0.80 | 0.90 | 1.00 | .0315 | .0354 | .0393 |
| b | 0.25 | --- | 0.50 | .0099 | --- | .0196 |
| c | 0.10 | --- | 0.26 | .004 | --- | .010 |
| D | 2.90 | 3.00 | 3.10 | .115 | .118 | .122 |
| E | 2.75 BSC | | | .108 BSC | | |
| E1 | 1.30 | 1.50 | 1.70 | .052 | .059 | .066 |
| e | 1.00 BSC | | | .039 BSC | | |
| L | 0.20 | 0.40 | 0.60 | .0079 | .0157 | .0236 |
| L1 | 0.30 BSC | | | .0118 BSC | | |
| θ | 0° | --- | 8° | 0° | --- | 8° |
| ooo | 0.10 | | | .004 | | |
| bbb | 0.15 | | | .006 | | |
| ccc | 0.25 | | | .010 | | |



TSOP-6 Part Marking Information



PART NUMBER CODE REFERENCE:

- | | |
|--------------|-------------|
| A = SJ3443DV | K = IRF5810 |
| B = IRF5800 | L = IRF5804 |
| C = IRF5850 | M = IRF5803 |
| D = IRF5851 | N = IRF5802 |
| E = IRF5852 | |
| F = IRF5801 | |
| I = IRF5805 | |
| J = IRF5806 | |

Notes:

- A line above the work week (as shown here) indicates Lead-Free
- A line below the part number (as shown here) indicates Cu-wire

W = (1-26) IF PRECEDED BY LAST DIGIT OF CALENDAR YEAR

| YEAR | Y | WORK WEEK | W |
|------|---|-----------|---|
| 2001 | 1 | 01 | A |
| 2002 | 2 | 02 | B |
| 2003 | 3 | 03 | C |
| 2004 | 4 | 04 | D |
| 2005 | 5 | | |
| 2006 | 6 | | |
| 2007 | 7 | | |
| 2008 | 8 | | |
| 2009 | 9 | | |
| 2010 | 0 | 24 | X |
| | | 25 | Y |
| | | 26 | Z |

W = (27-52) IF PRECEDED BY A LETTER

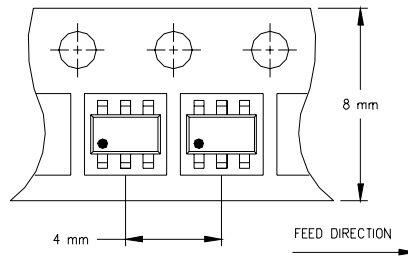
| YEAR | Y | WORK WEEK | W |
|------|---|-----------|---|
| 2001 | A | 27 | A |
| 2002 | B | 28 | B |
| 2003 | C | 29 | C |
| 2004 | D | 30 | D |
| 2005 | E | | |
| 2006 | F | | |
| 2007 | G | | |
| 2008 | H | | |
| 2009 | J | | |
| 2010 | K | 50 | X |
| | | 51 | Y |
| | | 52 | Z |

Note: For the most current drawing please refer to IR website at: <http://www.irf.com/package/>

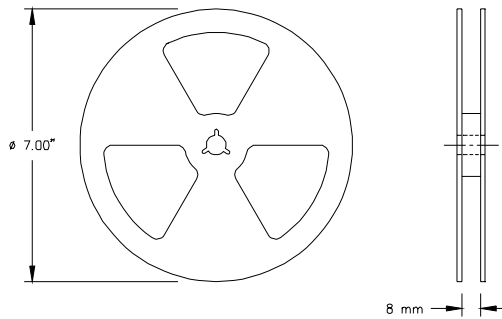
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TSOP-6 Tape & Reel Information



NOTES:
1. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES:
1. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Data and specifications subject to change without notice.
 This product has been designed and qualified for the Consumer market.
 Qualifications Standards can be found on IR's Web site.

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IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105
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